	L #	Hits	Search Text	DBs
1	L1	169659	1"438"/S CCIS	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
2	L2	810	<pre>1 and (SOI or silicon- on-insulator) near (transistor or MOSFET or FET)</pre>	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
3	L3	4	·	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
4	L4 .	1	contact?) and (date hear	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
5	L5	77		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
6	L7	0		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
7	L8	385	(body near contact?).ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
8	L10	0	9 and (first and second) near (isolat\$3 or (gate near extension))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
9	L9	7	8 and (SOI or silicon- on-insulator) near (transistor or MOSFET or FET)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
-10	L11	5	((SOI or silicon-on-insulator) near (transistor or MOSFET or FET)) and (body near contact?) and ((first and second) near ((source and isolation) or (gate near extension)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB